SMT POWER INDUCTORS
Shielded Drum Core - P1172/P1173 Series

Pulse
A TECHNITROL COMPANY

RoHS COMPLIANT

- **Height:** 8.0mm Max
- **Footprint:** 12.2mm x 12.2mm Max
- **Current Rating:** up to 14A
- **Inductance Range:** .8µH to 51µH

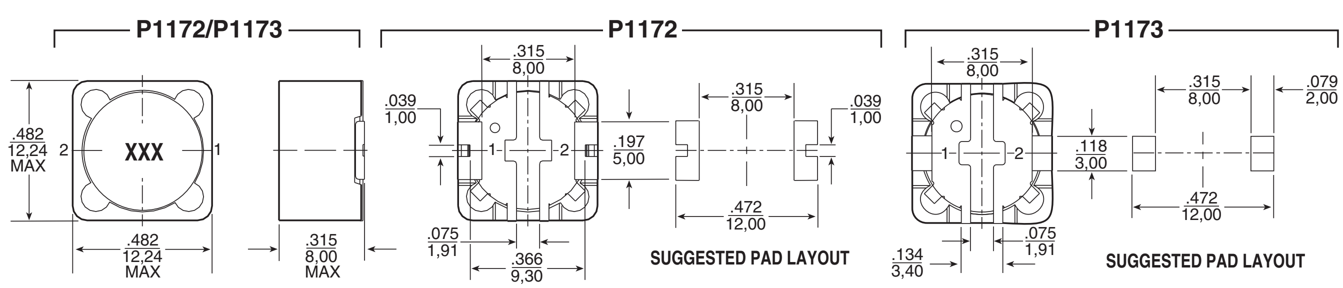
Electrical Specifications @ 25°C — Operating Temperature -40°C to +130°C

Part [2,3] Numbers		Inductance @0Adc (µH)	Inductance @Irated (µH) MIN	Irated [5] (Adc)	DCR (mΩ) TYP	DCR (mΩ) MAX	Saturation [6] Current -25% (A)	Heating [7] Current +40°C(A)	Core Loss [8] Factor (K2)	SRF (MHz)
P1172.132	P1173.132	1.3*	0.8	14	2.3	3	15	14	90	>40
P1172.202	P1173.202	2.0*	1.3	10	4.5	6	13	10	110	>40
P1172.272	P1173.272	2.7*	1.8	9	5.8	7.3	11	9	130	>40
P1172.372	P1173.372	3.7*	2.4	8.3	6.8	8.5	9.2	8.3	150	37
P1172.472	P1173.472	4.7*	3.1	7.9	7.6	9.5	8.2	7.9	170	33
P1172.602	P1173.602	6.0*	3.9	6	13	16.5	6.9	6	200	30
P1172.762	P1173.762	7.6*	4.9	5.7	14.3	18.5	6.2	5.7	220	25
P1172.103	P1173.103	10	7.5	5.2	17.3	21.8	5.5	5.2	250	20
P1172.123	P1173.123	12	9	4.5	23.3	29	5.1	4.5	280	18
P1172.153	P1173.153	15	11.3	4.1	28.3	35.4	4.4	4.1	300	15
P1172.183	P1173.183	18	13.5	4	29.4	37	4.3	4	340	13
P1172.223	P1173.223	22	16.5	3.8	33.2	42	3.8	3.8	370	12
P1172.273	P1173.273	27	20.3	3.4	36.2	45.9	3.4	3.6	410	11
P1172.333	P1173.333	33	24.8	3	49.3	64.8	3	3.1	460	10
P1172.393	P1173.393	39	29.3	2.7	65.2	81.5	2.8	2.7	490	8
P1172.473	P1173.473	47	35.3	2.6	71.4	89	2.6	2.6	550	7
P1172.683	P1173.683	68	51	2.1	108	135	2.1	2.1	670	6

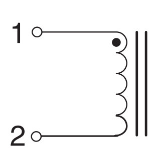
*Inductance at 0Adc tolerance on indicated part numbers is ±30%; tolerance is ±20% on all other parts.

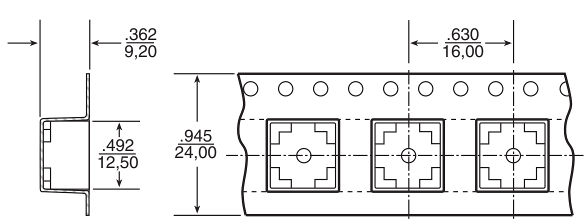
***NOTES FROM TABLE:** (See page 43)*

Mechanical



Schematic:





TAPE & REEL LAYOUT

Weight . . . . 4.5 grams
Tape & Reel. 400/reel

Dimensions: Inches / mm

Unless otherwise specified, all tolerances are ± .010 / 0,25

SMT POWER INDUCTORS
Shielded Drum Core Series

Pulse
A TECHNITROL COMPANY

Notes from Tables *(pages 27 - 42)*

1. Unless otherwise specified, all testing is made at 100kHz, 0.1VAC.
2. Optional Tape & Reel packaging can be ordered by adding a "T" suffix to the part number (i.e. P1166.102 becomes P1166.102T). Pulse complies with industry standard Tape and Tape & Reel specification EIA481.
3. To order RoHS compliant part, add the suffix "**NL**" to the part number (i.e. P1166.102 becomes P1166.102**NL** and P1166.102T becomes P1166.102**NL**T).
4. Temperature of the component (ambient plus temperature rise) must be within specified operating temperature range.
5. The rated current (Irated) as listed is either the saturation current or the heating current depending on which value is lower.
6. The saturation current, Isat, is the current at which the component inductance drops by the indicated percentage (typical) at an ambient temperature of 25°C. This current is determined by placing the component in the specified ambient environment and applying a short duration pulse current (to eliminate self-heating effects) to the component.
7. The heating current, Idc, is the DC current required to raise the component temperature by the indicated delta (approximately). The heating current is determined by mounting the component on a typical PCB and applying current for 30 minutes. The temperature is measured by placing the thermocouple on top of the unit under test.
8. In high volt*time (Et) or ripple current applications, additional heating in the component can occur due to core losses in the inductor which may necessitate derating the current in order to limit the temperature rise of the component. In order to determine the approximate total loss (or temperature rise) for a given application, both copper losses and core losses should be taken into account.

Estimated Temperature Rise:

Trise = $[\text{Total loss (mW)} / K0]^{.833}$ (°C)

Total loss = Copper loss + Core loss (mW)

Copper loss = I_{RMS}^2 x DCR (Typical) (mW)

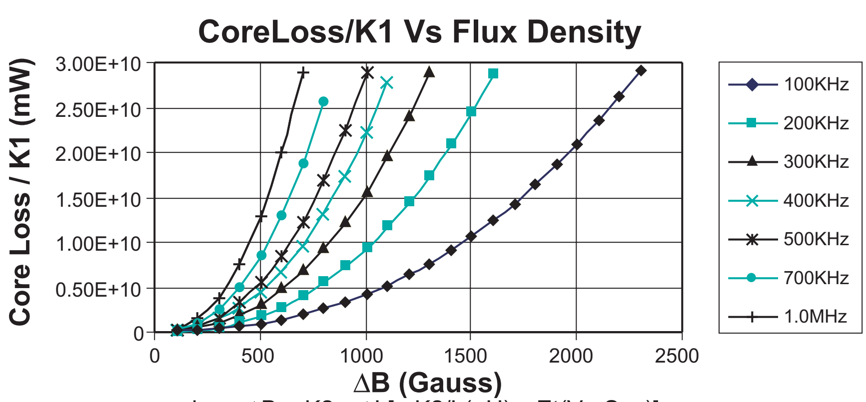
Irms = $[I_{DC}^2 + \Delta I^2/12]^{1/2}$ (A)

Core loss = K1 x $f\,(\text{kHz})^{1.23}$ x $\text{Bac(Ga)}^{2.38}$ (mW)

Bac (peak to peak flux density) = K2 x ΔI (Ga)
[= K2/L(μH) x Et(V-μSec) (Ga)]

where f varies between 25kHz and 1MHz, and Bac is less than 2500 Gauss.
K2 is a core size and winding dependant value and is given for each p/n in the proceeding datasheets.
K0 & K1 are platform and material dependant constants and are given in the table below for each platform.

Part No.	Trise Factor (K0)	Core Loss Factor (K1)
PG0085/86	2.3	5.29E-10
PG0087	5.8	15.2E-10
PG0040/41	0.8	2.80E-10
P1174	0.8	6.47E-10
PF0601	4.6	14.0E-10
PF0464	3.6	24.7E-10
PF0465	3.6	33.4E-10
P1166	1.9	29.6E-10
P1167	2.1	42.2E-10
PF0560NL	5.5	136E-10
P1168/69	4.8	184E-10
P1170/71	4.3	201E-10
P1172/73	5.6	411E-10
PF0552NL	8.3	201E-10
PF0553NL	7.1	411E-10



where ΔB = K2 x ΔI [= K2/L(μH) x Et(V-μSec)]

Take note that the component's temperature rise varies depending on the system condition. It is suggested that the component be tested at the system level, to verify the temperature rise of the component during system operation.